

AIA \$81.00

06-27-2006

1582980

PARTMENT OF COMMERCE
Patent and Trademark Office

6-15-06

RECORD
PATENT



103264661

JUN 15 2006

To the Director of the U.S. Patent and Trademark Office. Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

HU, Xianli
LI, Rujun
CHENG, Ning
LI, Haipeng

2. Name and address of receiving party(ies)

Name: ZTE Corporation

Internal Address: _____

Street Address: ZTE Plaza, Keji Road South, Hi-Tech

Industrial Park, Nanshan District

City: Shenzhen City

State: Guangdong Province

Country: P.R. China Zip: 518057

Additional name(s) of conveying party(ies) attached? Yes No

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) June 2, 2006

- Assignment Merger
- Security Agreement Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other _____

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

06/22/2006 GFREY1 00000134 10582980

04 C:8021

40.00.00

10/582980

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Michael N. Lau

Internal Address: _____

Street Address: 7701 Rockledge Court

City: Springfield

State: VA Zip: 22152

Phone Number: 703-637-0488

Fax Number: 703-644-4303

Email Address: M-Lau@michaelnlau.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers 1008
Expiration Date 02/08

b. Deposit Account Number 502840

Authorized User Name Michael Lau/Lau & Asso.

9. Signature: Michael Lau

Signature

6/15/2006

Date

Michael N. Lau

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

4

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

WHEREAS, I/WE, the Unsigned Inventor(s) have made a certain invention

entitled: ^(title) Route Serving Device, Method and System Applying the Device

_____ filed on
(date) June 15, 2006, with a Patent Application No. ^(if known) TBD

_____, for which I/WE have made an application for letters patent of
the United States of America; and

WHEREAS, ^(name of corporation) ZTE Corporation

_____ (hereinafter Corporation), a corporation, having its
principal place of business in the ^(full address) ZTE Plaza, Keji Road South, Hi-Tech
Industrial Park, Nanshan District, Shenzhen City, Guangdong Province, 518057 China

_____ is desirous
of acquiring an interest therein.

NOW, THEREFORE, in consideration of Ten Dollars (US \$10.00), in
currency of the United States of America, and other good and valuable
consideration, the receipt and sufficiency of which is hereby acknowledged,
I/WE, the Undersigned Inventor(s), by these presents, do sell, assign and
transfer unto said Corporation, my/our entire right, title and interest, for the
United States of America and its possessions and territories, and all foreign
countries, in and to said invention as described and claimed in an application
for letters patent of the United States of America, preparatory to obtaining

LAU & ASSOCIATES
WWW.MICHAEL.NLAU.COM
MICHAEL.LAU_@YAHOO.COM

letters patent of the United States of America therefor, said application for letters patent of the United States of America, together with the right to file additional applications for letters patents or other forms of protection for said invention in all foreign countries, including all rights of priority created or conferred by any international convention or treaty to which the United States of America is a party or signatory, and in and to any letters patents or other forms of protection that may be granted for said invention; said invention, applications for patents or other forms of protection and letters patents or other forms of protection, and any continuation, continuations-in-part, divisions, reissues, extensions and renewals thereof, to be held and enjoyed by said Corporation, for its use and behoof and for its legal representatives, successors and assigns, to the full ends of the terms for which said letters patents or other forms of protection may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

For the same consideration, I/WE hereby covenant and agree that I/WE will and that my/our legal representative shall execute and deliver any and all application papers, assignments, powers of attorney and other instruments that said Corporation may consider necessary or advisable to secure letters patents or other forms of protection of the United States of America and all foreign countries for said invention, and any continuations, continuations-in-part, divisions, reissues, extensions and renewals thereof, and to vest and confirm in said Corporation, the full and complete legal and equitable title to said invention, applications and letters patents or other forms of protection, without further consideration than that now paid but at the expense of said Corporation, its successors or assigns.

Full name of sole or first inventor: Xianli Hu

Inventor's signature:

Xianli Hu

Date:

June 2, 2006

Address: ZTE Plaza, Keji Road South, Hi-Tech Industrial Park, Nanshan District, Shenzhen City,
Guangdong Province, 518057 China

Full name of second inventor: Rujun Li

Inventor's signature:

Rujun Li

Date:

June 2, 2006

Address: ZTE Plaza, Keji Road South, Hi-Tech Industrial Park, Nanshan District, Shenzhen City,
Guangdong Province, 518057 China

Full name of third inventor: Ning Cheng

Inventor's signature:

Ning Cheng

Date:

June 2, 2006

Address: ZTE Plaza, Keji Road South, Hi-Tech Industrial Park, Nanshan District, Shenzhen City,
Guangdong Province, 518057 China

Full name of fourth inventor: Haipeng Li

Inventor's signature:

Haipeng li

Date:

June 2, 2006

Address: ZTE Plaza, Keji Road South, Hi-Tech Industrial Park, Nanshan District, Shenzhen City,
Guangdong Province, 518057 China